

2SB0938, 2SB0938A (2SB938, 2SB938A)

Silicon PNP epitaxial planar type Darlington

For power amplification and switching

Complementary to 2SD1261 and 2SD1261A

Features

- High forward current transfer ratio h_{FE}
- High-speed switching
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Rated	Unit
Collector to base voltage	V_{CBO}	-60	V
2SB0938		-80	
Collector to emitter voltage	V_{CEO}	-60	V
2SB0938A		-80	
Emitter to base voltage	V_{EBO}	-5	V
Peak collector current	I_{CP}	-8	A
Collector current	I_C	-4	A
Collector power dissipation	P_C	40	W
$T_C=25^\circ\text{C}$		1.3	
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

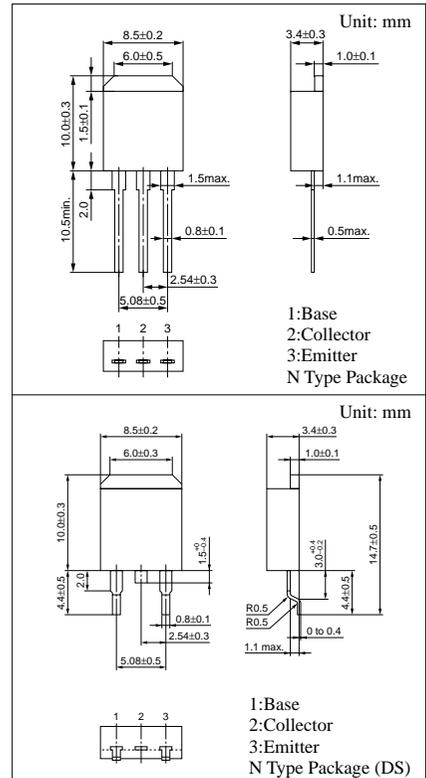
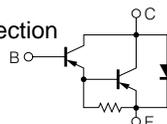
Electrical Characteristics ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = -60\text{V}, I_E = 0$			-200	μA
2SB0938A		$V_{CB} = -80\text{V}, I_E = 0$			-200	
Collector cutoff current	I_{CEO}	$V_{CE} = -30\text{V}, I_B = 0$			-500	μA
2SB0938A		$V_{CE} = -40\text{V}, I_B = 0$			-500	
Emitter cutoff current	I_{EBO}	$V_{EB} = -5\text{V}, I_C = 0$			-2	mA
Collector to emitter voltage	V_{CEO}	$I_C = -30\text{mA}, I_B = 0$	-60			V
2SB0938A			-80			
Forward current transfer ratio	h_{FE1}	$V_{CE} = -3\text{V}, I_C = -0.5\text{A}$	1000			
	h_{FE2}^*	$V_{CE} = -3\text{V}, I_C = -3\text{A}$	2000		10000	
Base to emitter voltage	V_{BE}	$V_{CE} = -3\text{V}, I_C = -3\text{A}$			-2.5	V
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = -3\text{A}, I_B = -12\text{mA}$			-2	V
		$I_C = -5\text{A}, I_B = -20\text{mA}$			-4	
Transition frequency	f_T	$V_{CE} = -10\text{V}, I_C = -0.5\text{A}, f = 1\text{MHz}$		15		MHz
Turn-on time	t_{on}	$I_C = -3\text{A}, I_{B1} = -12\text{mA}, I_{B2} = 12\text{mA}$		0.3		μs
Storage time	t_{stg}		2		μs	
Fall time	t_f		0.5		μs	

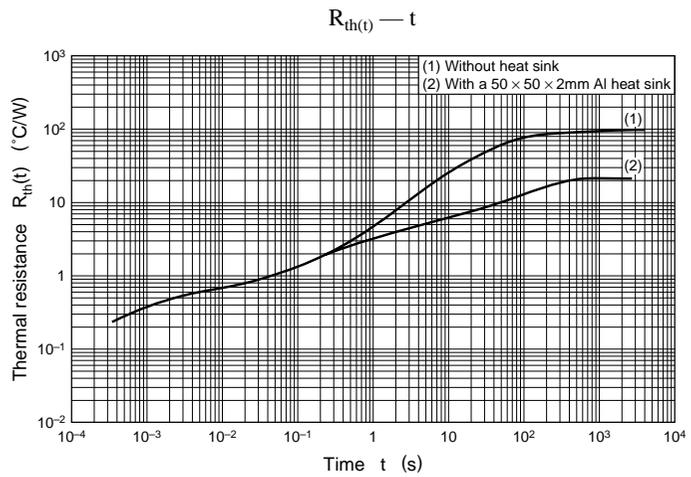
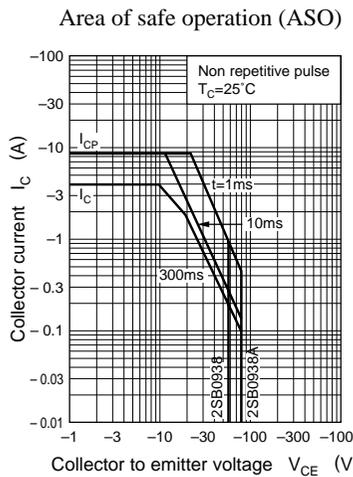
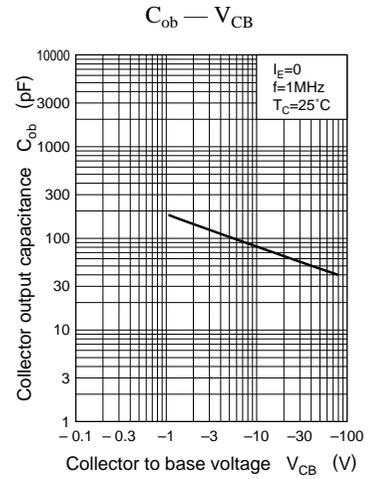
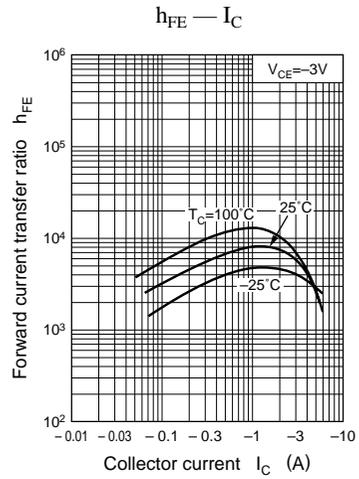
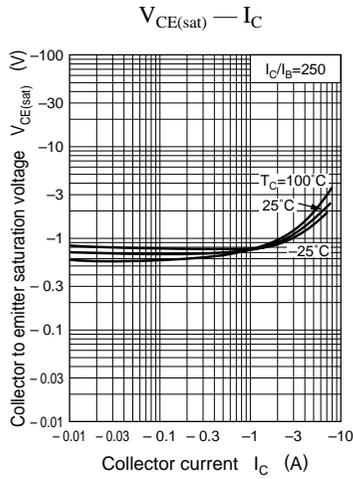
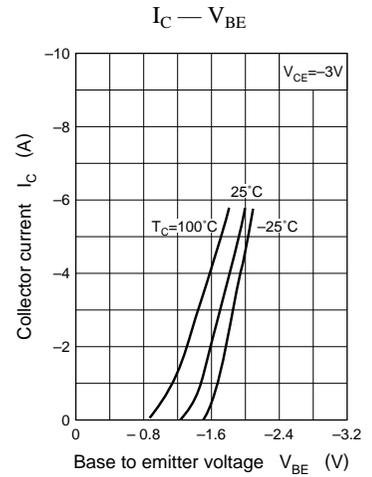
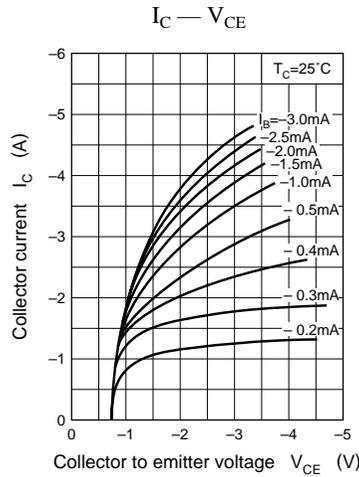
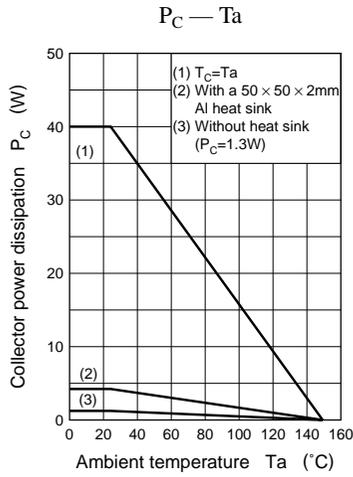
* h_{FE2} Rank classification

Rank	Q	P
h_{FE2}	2000 to 5000	4000 to 10000

Internal Connection



Note) The part numbers in the parenthesis show conventional part number.



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